



SDM10M45SD

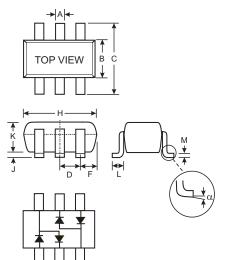
SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 4)
- "Green" Device (Note 5 and 6)

Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound, Note 6. UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Polarity: See Diagram
- Marking: KLG, See Page 2
- Ordering Information: See Below
- Weight: 0.016 grams (approximate)



| | SOT-26 | | | | | | | | | |
|-------|--------|---------|------|--|--|--|--|--|--|--|
| Dim | Min | Max | Тур | | | | | | | |
| Α | 0.35 | 0.50 | 0.38 | | | | | | | |
| В | 1.50 | 1.70 | 1.60 | | | | | | | |
| С | 2.70 | 3.00 | 2.80 | | | | | | | |
| D | | | 0.95 | | | | | | | |
| F | | | 0.55 | | | | | | | |
| Н | 2.90 | 3.10 | 3.00 | | | | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | | | | |
| K | 1.00 | 1.30 | 1.10 | | | | | | | |
| L | 0.35 | 0.55 | 0.40 | | | | | | | |
| М | 0.10 | 0.20 | 0.15 | | | | | | | |
| α | 0° | 8° | | | | | | | | |
| All D | imens | ions in | mm | | | | | | | |

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Maximum Ratings @ T_A = 25°C unless otherwise specified

| Characteristic | | Symbol | Value | Unit | |
|--|-------------------|--|-------------|------|--|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | | V _{RRM} V _{RWM} V _R | 45 | V | |
| RMS Reverse Voltage | | V _{R(RMS)} | 40 | V | |
| Forward Continuous Current (Note 1) | | I _{FM} | 100 | mA | |
| Forward Surge Current @ t < 8.3ms | | I _{FSM} | 1.0 | Α | |
| Power Dissipation (Note 1) | | P _d | 225 | mW | |
| Thermal Resistance Junction to Amb | ient Air (Note 1) | $R_{	hetaJA}$ | 444 | °C/W | |
| Operating and Storage Temperature | Range | T _i , T _{STG} | -40 to +125 | °C | |

Electrical Characteristics @ T_A = 25°C unless otherwise specified

| Characteristic | | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|--------------------|-----|------|-----|------|----------------------------------|
| Reverse Breakdown Voltage (Note 2) | V _{(BR)R} | 45 | _ | _ | _ | I _R = 100μA |
| Forward Voltage | VF | _ | 370 | 450 | mV | I _F = 10mA |
| Reverse Leakage Current (Note 2) | I _R | _ | 0.07 | 1.0 | μА | V _R = 10V |
| Total Capacitance | C _T | _ | 6.0 | _ | pF | V _R = 10V, f = 1.0MHz |

Ordering Information (Note 3 & 6)

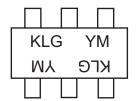
| Device | Packaging | Shipping | | |
|----------------|-----------|------------------|--|--|
| SDM10M45SD-7-F | SOT-26 | 3000/Tape & Reel | | |

Note: 1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

- 2. Short duration pulse test to minimize self-heating effect.
- 3. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- 4. No purposefully added lead.
- 5. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 6. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Marking Information

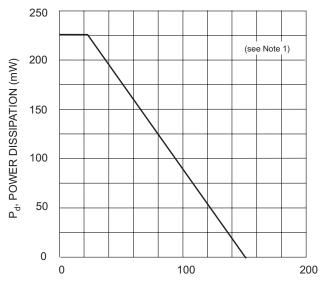


KLG = Product Type Marking Code YM = Date Code Marking Y = Year ex: P = 2003 M = Month ex: 9 = September

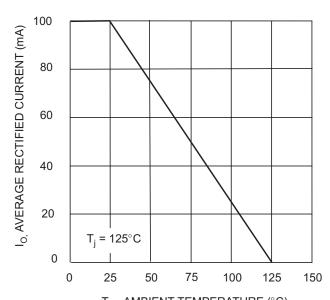
Date Code Key

| Yea | Year | | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|-------|------|-----|-------|------|------|------|------|------|------|------|------|------|
| Code | | Р | R | S | Т | U | V | W | Х | Υ | Z | |
| Month | .lan | Feb | March | Anr | May | Jun | Jul | Διια | Sen | Oct | Nov | Dec |

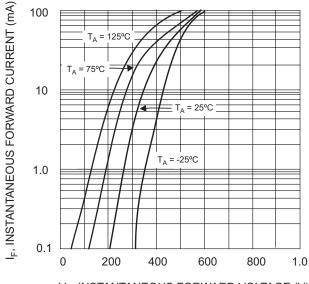
| Month | Jan | Feb | March | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



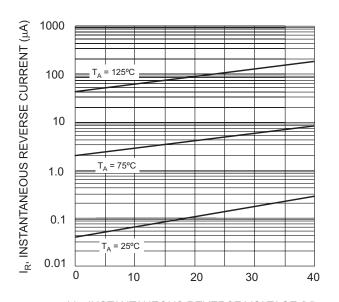
T_A, AMBIENT TEMPERATURE (°C) Fig. 1, Power Derating Curve



T_A, AMBIENT TEMPERATURE (°C) Fig. 2 Forward Current Derating Curve (Per Element)



V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 3 Typical Forward Characteristics



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m V_R}$, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 4 Typical Reverse Characteristics



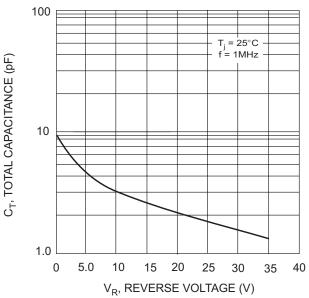


Fig. 5 Total Capacitance vs. Reverse Voltage, Per Element

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